

WDM504N019LS-AH

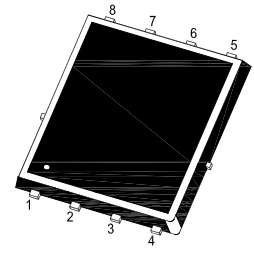
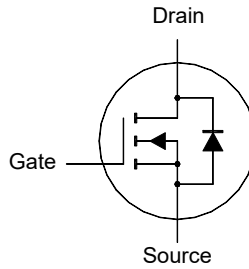
N-Channel Enhancement Mode MOSFET

Features

- AEC-Q101 Qualified
- Low $R_{DS(ON)}$
- Halogen and Antimony Free(HAF), RoHS compliant

Application

- Load Switch
- DC-DC converters



1.Source 2.Source 3.Source 4.Gate
5.Drain 6.Drain 7.Drain 8.Drain
DFN5060 Plastic Package

Key Parameters

Parameter	Value	Unit
BV_{DSS}	40	V
$R_{DS(ON)}$ Max	2.5 @ $V_{GS} = 10\text{ V}$	m Ω
	3.8 @ $V_{GS} = 4.5\text{ V}$	
$V_{GS(th)}$ typ	1.4	V
Q_g typ	48 @ $V_{GS} = 10\text{ V}$	nC

Absolute Maximum Ratings (at $T_a = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	40	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current	I_D	100	A
		63	
Peak Drain Current, Pulsed ¹⁾	I_{DM}	450	A
Avalanche Current	I_{AS}	49.7	A
Single Pulse Avalanche Energy ²⁾	E_{AS}	123.5	mJ
Power Dissipation	P_D	45.2	W
Operating Junction and Storage Temperature Range	T_J, T_{stg}	- 55 to + 150	$^\circ\text{C}$

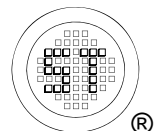
Thermal Characteristics

Parameter	Symbol	Max.	Unit
Thermal Resistance from Junction to Case	$R_{\theta JC}$	2.7	$^\circ\text{C/W}$
Thermal Resistance from Junction to Ambient ³⁾	$R_{\theta JA}$	45	$^\circ\text{C/W}$

¹⁾ Pulse Test: Pulse Width $\leq 100\text{ }\mu\text{s}$, Duty Cycle $\leq 2\%$, Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)} = 150^\circ\text{C}$.

²⁾ Limited by $T_{J(MAX)}$, starting $T_J = 25^\circ\text{C}$, $L = 0.1\text{ mH}$, $R_g = 25\text{ }\Omega$, $I_D = 49.7\text{ A}$, $V_{GS} = 10\text{ V}$.

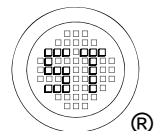
³⁾ Device mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper plate in still air.



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Characteristics at $T_a = 25^\circ\text{C}$ unless otherwise specified

Parameter	Symbol	Min.	Typ.	Max.	Unit
STATIC PARAMETERS					
Drain-Source Breakdown Voltage at $I_D = 250\ \mu\text{A}$	BV_{DSS}	40	-	-	V
Drain-Source Leakage Current at $V_{DS} = 32\ \text{V}$	I_{DSS}	-	-	1	μA
Gate Leakage Current at $V_{GS} = \pm 20\ \text{V}$	I_{GSS}	-	-	± 100	nA
Gate-Source Threshold Voltage at $V_{DS} = V_{GS}$, $I_D = 250\ \mu\text{A}$	$V_{GS(th)}$	1.2	-	2.5	V
Drain-Source On-State Resistance at $V_{GS} = 10\ \text{V}$, $I_D = 23\ \text{A}$ at $V_{GS} = 4.5\ \text{V}$, $I_D = 18\ \text{A}$	$R_{DS(on)}$	- -	1.9 2.9	2.5 3.8	m Ω
DYNAMIC PARAMETERS					
Forward Transconductance at $V_{DS} = 5\ \text{V}$, $I_D = 5\ \text{A}$	g_{fs}	-	27	-	S
Gate resistance at $V_{DS} = 0\ \text{V}$, $f = 1\ \text{MHz}$	R_g	-	0.7	-	Ω
Input Capacitance at $V_{GS} = 0\ \text{V}$, $V_{DS} = 25\ \text{V}$, $f = 1\ \text{MHz}$	C_{iss}	-	2979	-	pF
Output Capacitance at $V_{GS} = 0\ \text{V}$, $V_{DS} = 25\ \text{V}$, $f = 1\ \text{MHz}$	C_{oss}	-	552	-	pF
Reverse Transfer Capacitance at $V_{GS} = 0\ \text{V}$, $V_{DS} = 25\ \text{V}$, $f = 1\ \text{MHz}$	C_{rss}	-	34	-	pF
Gate charge total at $V_{DS} = 25\ \text{V}$, $I_D = 23\ \text{A}$, $V_{GS} = 10\ \text{V}$ at $V_{DS} = 25\ \text{V}$, $I_D = 23\ \text{A}$, $V_{GS} = 4.5\ \text{V}$	Q_g	- -	48 22	- -	nC
Gate to Source Charge at $V_{DS} = 25\ \text{V}$, $I_D = 23\ \text{A}$, $V_{GS} = 10\ \text{V}$	Q_{gs}	-	9	-	nC
Gate to Drain Charge at $V_{DS} = 25\ \text{V}$, $I_D = 23\ \text{A}$, $V_{GS} = 10\ \text{V}$	Q_{gd}	-	7	-	nC
Turn-On Delay Time at $V_{GS} = 10\ \text{V}$, $V_{DS} = 25\ \text{V}$, $I_D = 23\ \text{A}$, $R_g = 3.3\ \Omega$	$t_{d(on)}$	-	19	-	nS
Turn-On Rise Time at $V_{GS} = 10\ \text{V}$, $V_{DS} = 25\ \text{V}$, $I_D = 23\ \text{A}$, $R_g = 3.3\ \Omega$	t_r	-	42	-	nS
Turn-Off Delay Time at $V_{GS} = 10\ \text{V}$, $V_{DS} = 25\ \text{V}$, $I_D = 23\ \text{A}$, $R_g = 3.3\ \Omega$	$t_{d(off)}$	-	17	-	nS
Turn-Off Fall Time at $V_{GS} = 10\ \text{V}$, $V_{DS} = 25\ \text{V}$, $I_D = 23\ \text{A}$, $R_g = 3.3\ \Omega$	t_f	-	7	-	nS
Body-Diode PARAMETERS					
Drain-Source Diode Forward Voltage at $I_S = 23\ \text{A}$, $V_{GS} = 0\ \text{V}$	V_{SD}	-	-	1.3	V
Body-Diode Continuous Current	I_S	-	-	100	A
Body-Diode Continuous Current, Pulsed	I_{SM}	-	-	450	A
Body Diode Reverse Recovery Time at $I_S = 23\ \text{A}$, $di/dt = 100\ \text{A} / \mu\text{s}$	t_{rr}	-	26.4	-	nS
Body Diode Reverse Recovery Charge at $I_S = 23\ \text{A}$, $di/dt = 100\ \text{A} / \mu\text{s}$	Q_{rr}	-	17.6	-	nC



Electrical Characteristics Curves

Fig. 1 Typical Output Characteristic

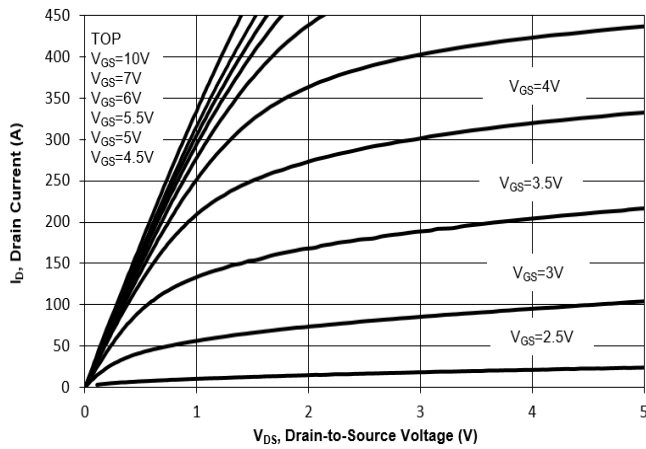


Fig. 2 Typical Transfer Characteristic

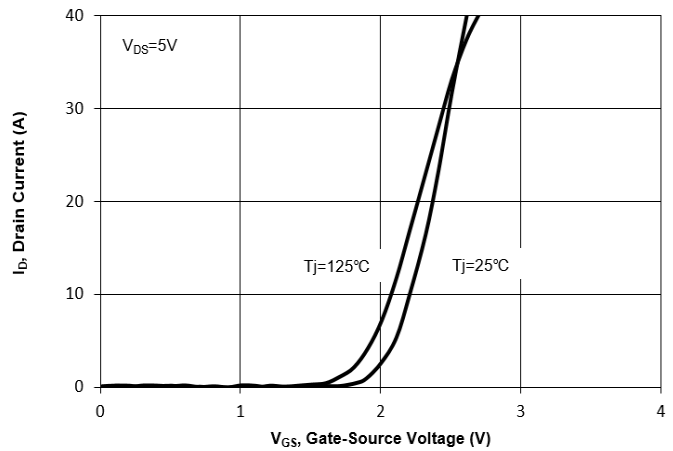


Fig. 3 On-Resistance vs. Drain Current

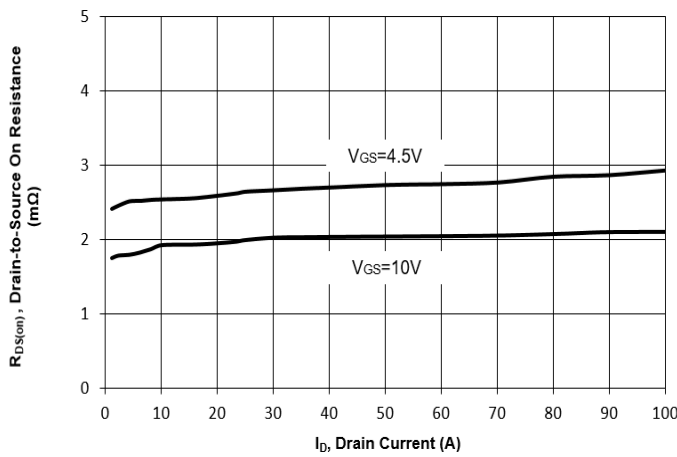


Fig. 4 On-Resistance vs. Gate Voltage

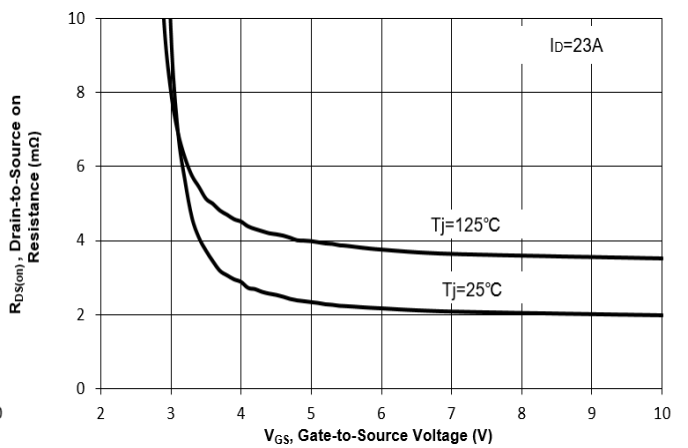


Fig. 5 On-Resistance vs. Tj

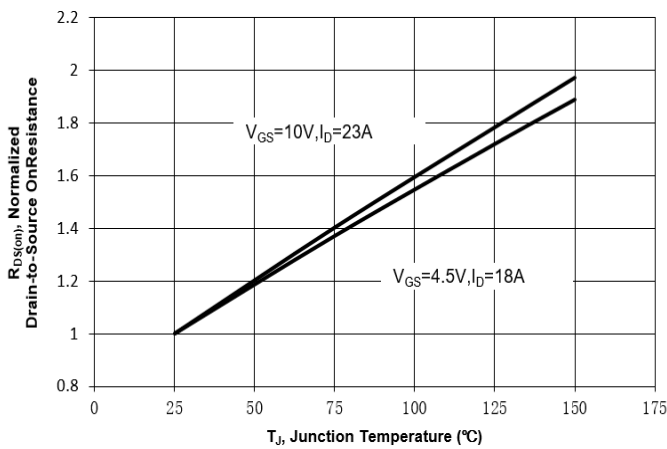
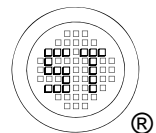
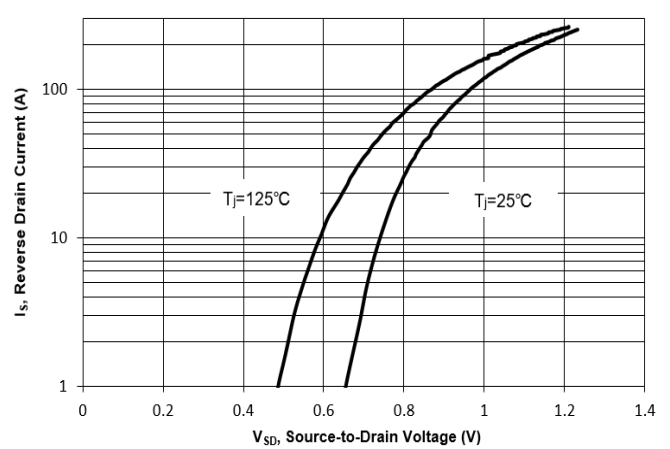


Fig. 6 Typical Body-Diode Forward Characteristic



Electrical Characteristics Curves

Fig. 7 Typical Junction Capacitance

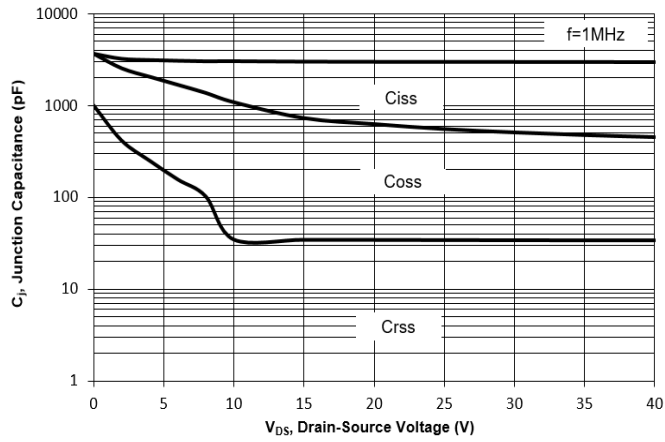


Fig. 8 Drain-Source Leakage Current vs. T_J

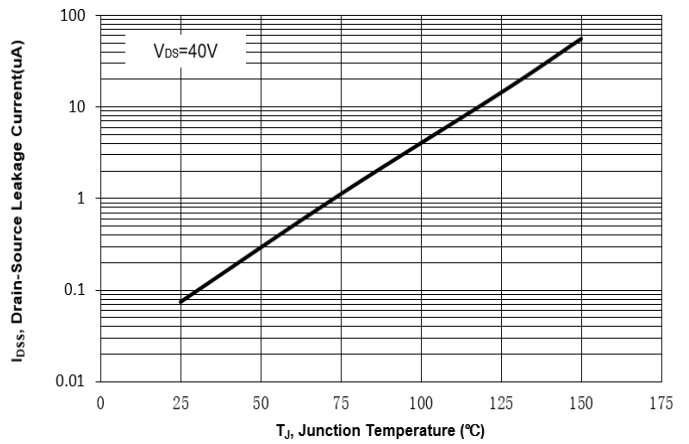


Fig. 9 V_{(BR)DSS} vs. Junction Temperature

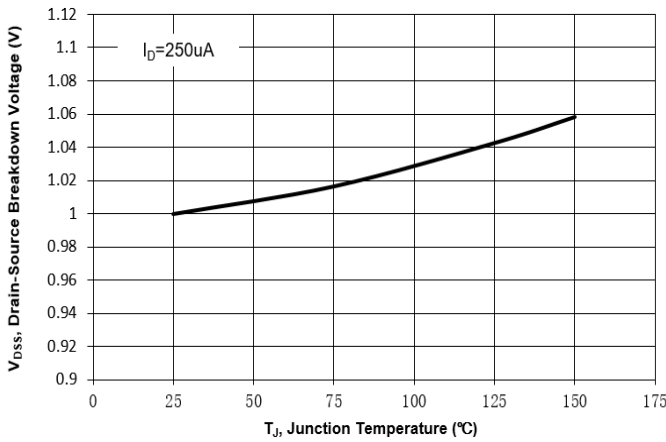


Fig. 10 Gate Threshold Variation vs. T_J

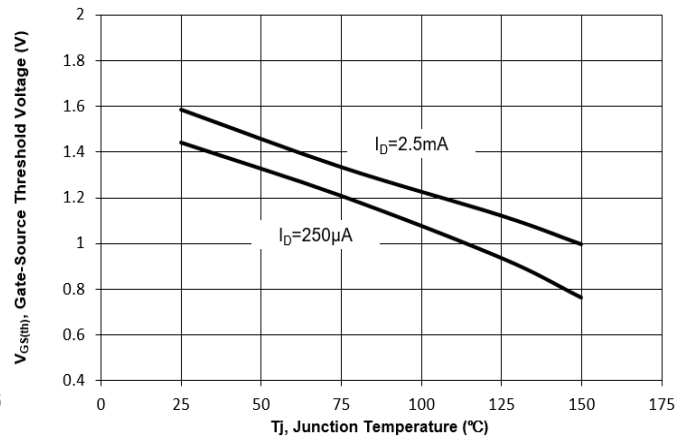


Fig. 11 Gate Charge

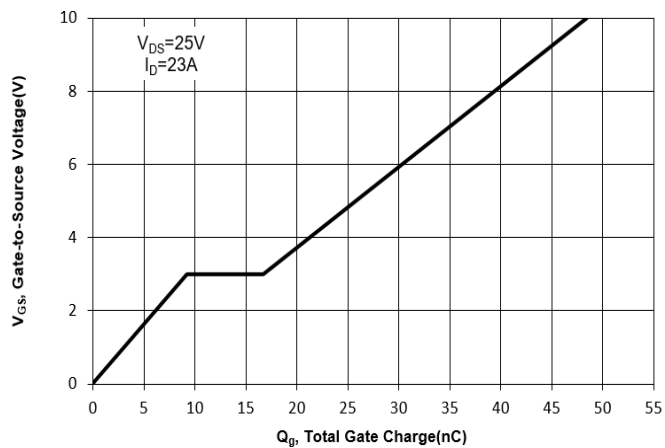
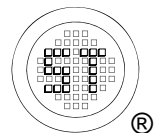
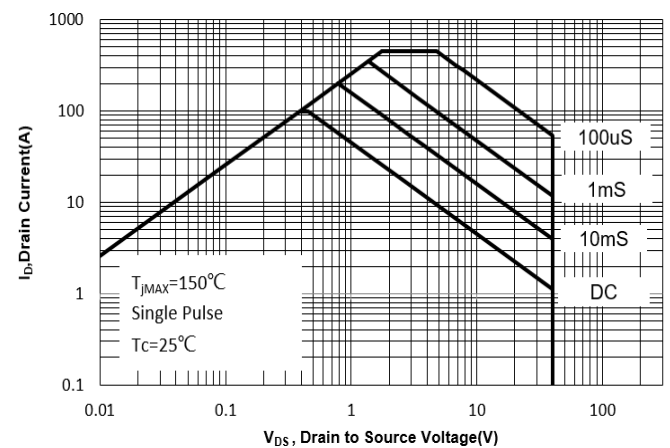


Fig. 12 Safe Operation Area



Electrical Characteristics Curves

Fig. 13 Normalized Maximum Transient Thermal Impedance($z_{\theta JC}$)

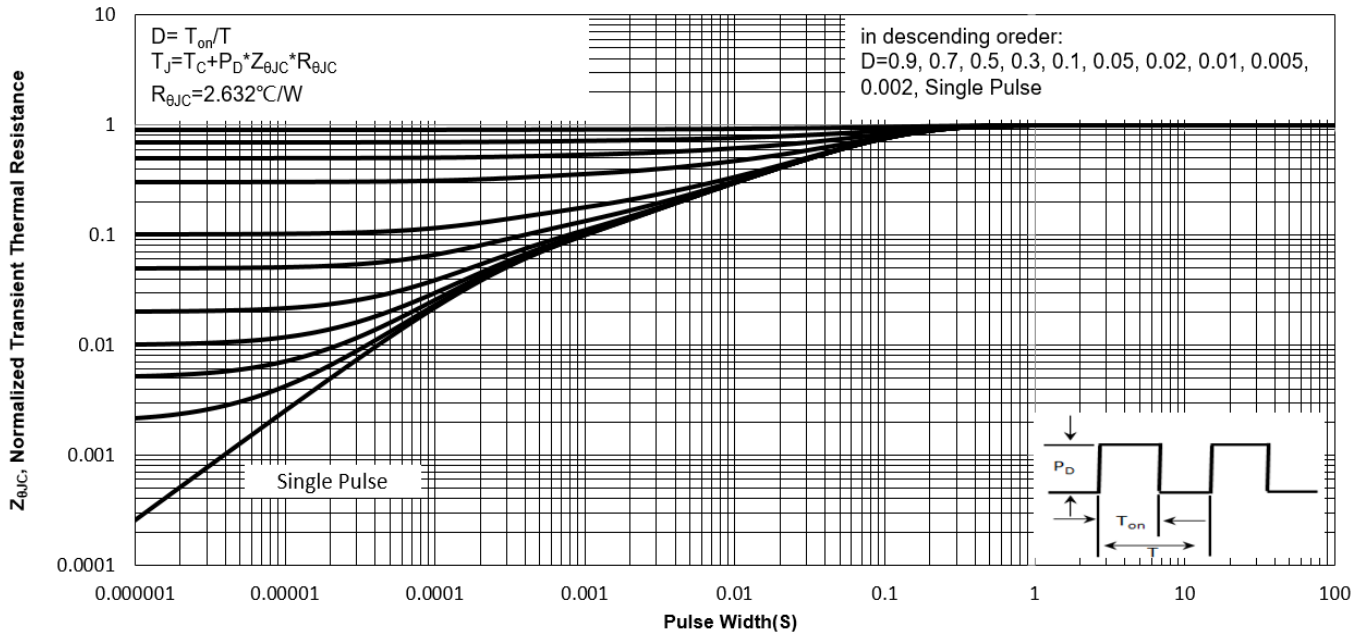
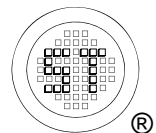
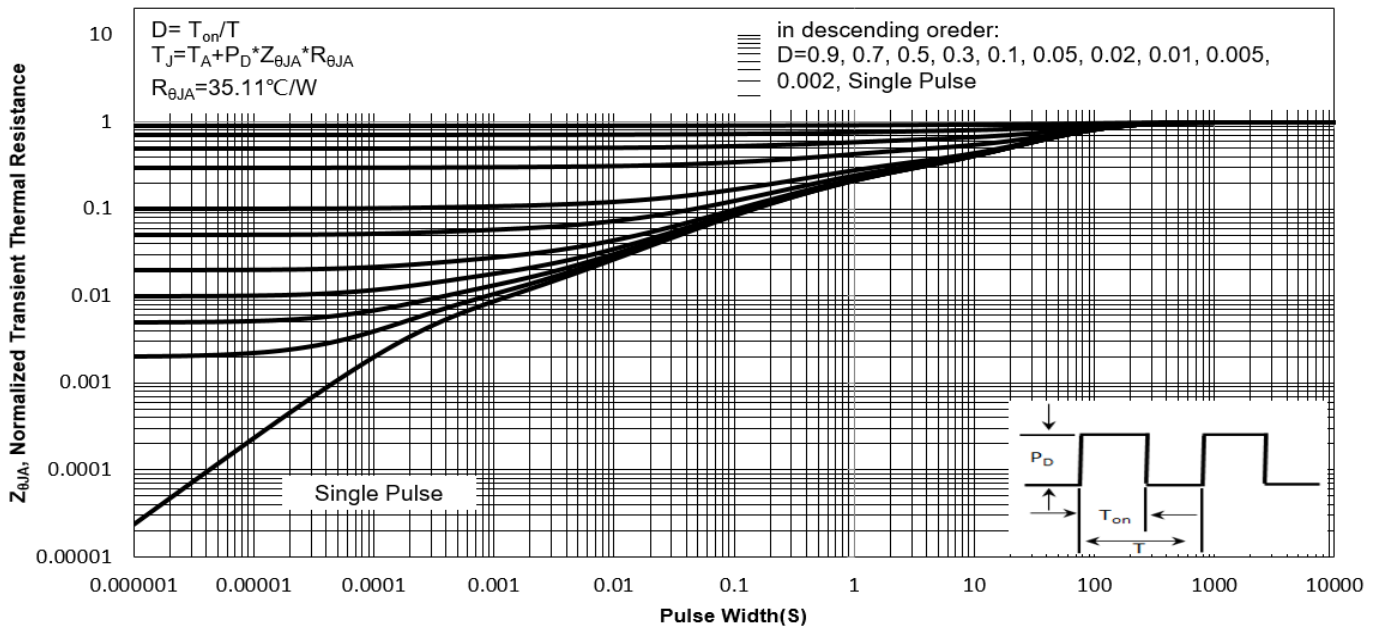


Fig. 14 Normalized Maximum Transient Thermal Impedance($z_{\theta JA}$)



Test Circuits

Fig.1-1 Switching times test circuit

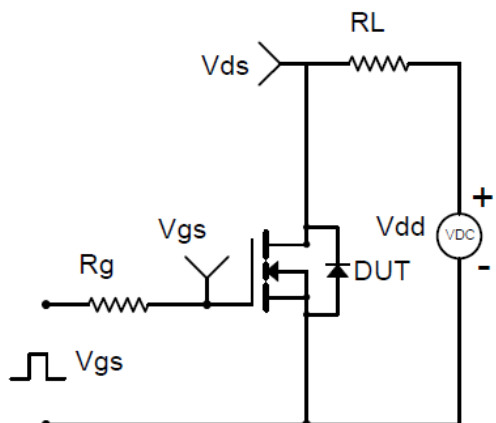


Fig.1-2 Switching Waveform

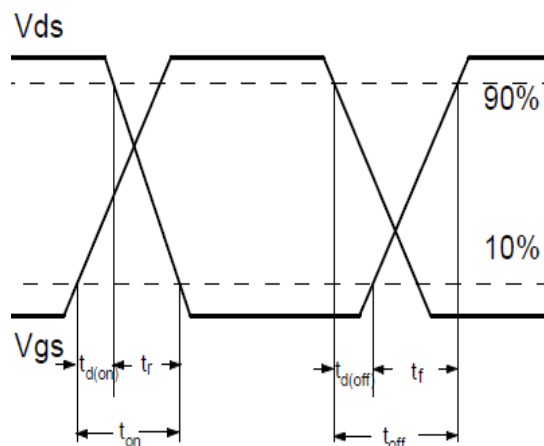


Fig.2-1 Gate charge test circuit

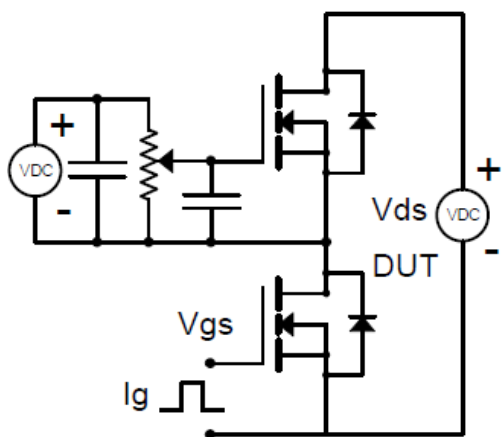


Fig.2-2 Gate charge waveform

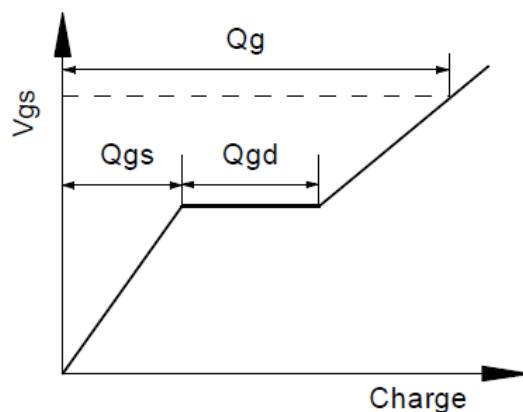


Fig.3-1 Avalanche test circuit

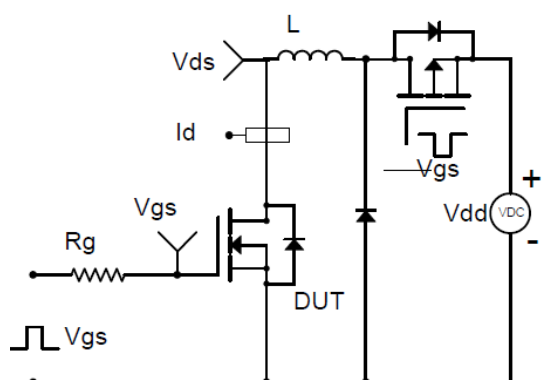
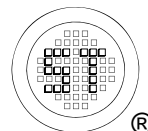
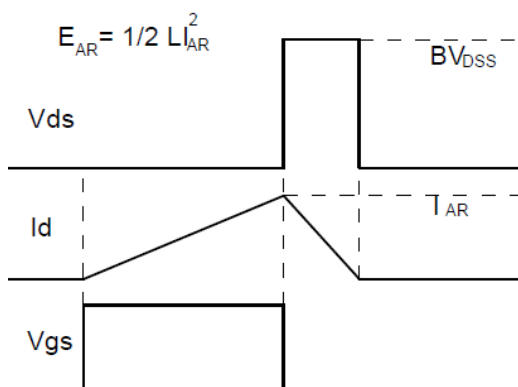


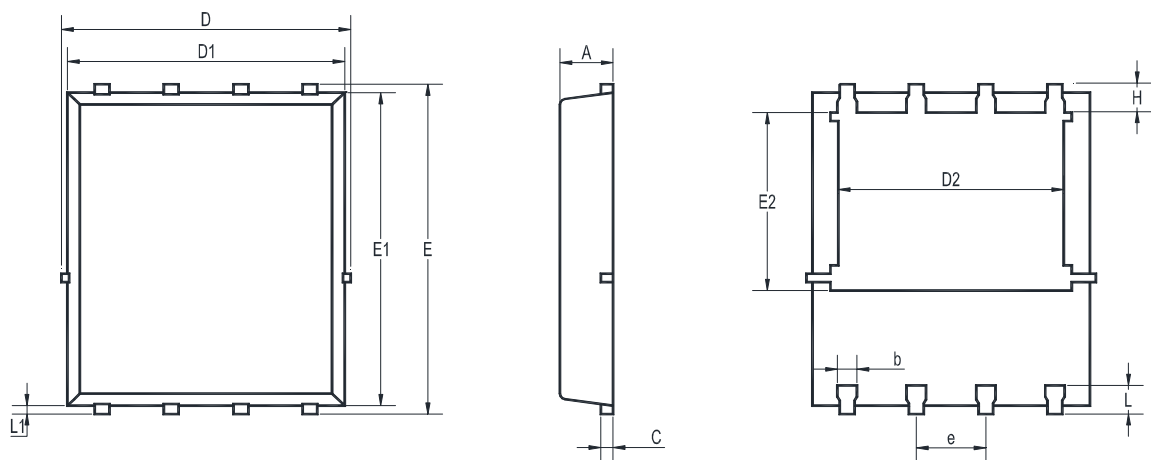
Fig.3-2 Avalanche waveform



WDM504N019LS-AH

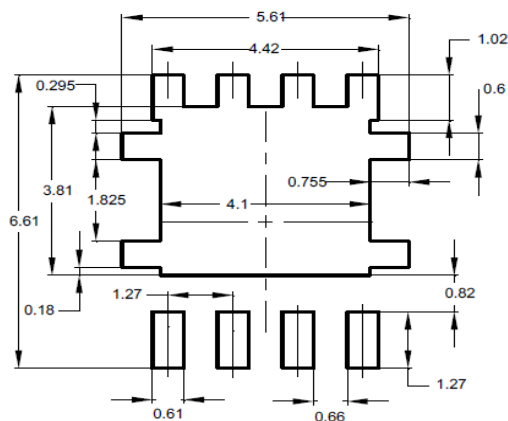
Package Outline Dimensions (Units: mm)

DFN5060



UNIT	A	b	C	D	D1	D2	E	E1	E2	e	L	L1	H
mm	1.12 0.9	0.51 0.33	0.34 0.11	5.26 4.7	5.1 4.7	4.5 3.56	6.25 5.75	6 5.6	3.66 3.18	1.37 1.17	0.71 0.35	0.2 0.06	0.71 0.35

Recommended Soldering Footprint

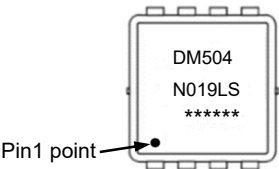


Packing information

Package	Tape Width (mm)	Pitch		Reel Size		Per Reel Packing Quantity
		mm	inch	mm	inch	
DFN5060	12	8 ± 0.1	0.315 ± 0.004	330	13	5,000

Marking information

" DM504N019LS " = Part No.
" ***** " = Date Code Marking
Font type: Arial



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